Dotted box > PCB manufacturer info

- 1							
4	Layer Name	Туре	Material	Thickness (mm)	Color	Epsilon R	Loss Tangent
	F.Silkscreen	Top Silk Screen	Not specified	0 mm	Not specified	1	0
	F.Paste	Top Solder Paste		0 mm		1	0
	F.Mask	Top Solder Mask	Not specified	0.01 mm	Not specified	3.3	0
	F.Cu	copper		0.035 mm		1	0
	Dielectric	core	FR4	1.51 mm	Not specified	4.5	0.02
	B.Cu	copper		0.035 mm		1	0
	B.Mask	Bottom Solder Mask	Not specified	0.01 mm	Not specified	3.3	0
	B.Paste	Bottom Solder Paste		0 mm		1	0
	B.Silkscreen	Bottom Silk Screen	Not specified	0 mm	Not specified	1	0

BOARD CHARACTERISTICS

Copper Layer Count: Board overall dimensions: 19.0500 mm x 50.7951 mm

0.0000 mm / 0.2540 mm

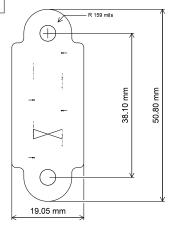
Copper Finish: HASL Castellated pads: No Edge card connectors: No

Min track/spacing:

Outer Copper Weight: 1 oz Tented Via type:

Board Thickness: 1.6000 mm

Min hole diameter: 0.3000 mm _____ Impedance Control: Plated Board Edge:



NOTES **LAYERS** 1.Layers: 2 2.Thickness: 1.6 3.Surface finish: HASL 4.Outer Copper Weight: 1oz 5 Via covering: Tented User.1 6.Min hole size: .3mm 7.Gold Fingers: No 8.Castellated Holes: No

9.Edge Plating: No

Edge Cuts



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Title:			11		
Size: A4	Date:	Rev:	1		
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